2002/004

Docket No.: JCLA29182

Form 1595 (Rev. 09/04) RECORDATION FORM (COVER SHEET U.S. Department of Commerce Patent and Trademark Office	
PATENTS ONLY		
To the Director of the U.S. Patent and Trademark Office: Please record the attached documents or the new address(es) below.		
1. Name of conveying party(ies): Names(s)	2. Name/address of receiving Party(ies): 1. United Microelectronics Corp. No. 3, Li-Hsin Rd. II, Science-Based Industrial Park, Hsinchu, Taiwan, R.O.C.	
	Add'1 name(s)/address(es) of receiving parties Attached? □ Yes ☒ No	
4. Application number(s) or patent number(s);		
A. Patent Application No. (s)	B. Patent No. (s)	
12/431,137		
Additional numbers attached?	☐ Yes ⊠ No	
Name and address of party to whom Correspondence concerning document should be mailed:	6. Total No. of applications and patents involved: ONE(1)	
J. C. Patents 4, Venture Suite 250 Irvine, CA. 92618 Tel: (949) 660-0761 Fax: (949) 660-0809 E-mail: jcpi@email.msn.com	7. Total fee (37 CFR §3.41): \$40.00 □ Authorized to be charge by credit card □ Authorized to be charge to deposit account □ Enclosed □ None required (government interest not affecting title) 8. Payment Information a. Credit Card Last Numbers Expiration Date b. Deposit Account Number 50-0710	
Atty Docket No.: JCLA29182	Authorized User Name <u>Jiawei Huang</u>	
9. Statement and Signature: To the best of my knowledge and belief, the fore attached copy is a true copy of the original document.	nent.	
Jiawei Huang Name of Person Signing Registration No. 43,330 Signature	$\frac{4-28-2009}{\text{Date}}$ Total number of pages including cover sheet, attachments, and documents: 3	

PATENT REEL: 022607 FRAME: 0113 UMCD-2008-0061 29182-US-PA

ASSIGNMENT

WHEREAS,

- 1. Kai-Ling Chiu
- 3. Chih-Yu Tseng
- 5. Chia-Te Chien

- 2. Victor Chiang Liang
- 4. Hui-Sheng Chang
- 6. You-Ren Liu

hereinafter referred to as ASSIGNOR, has/have invented certain new and useful improvements as described and set forth in the below identified application for United States Letters Patent:

Title: CAPACITOR STRUCTURE

[] Filed:

Serial No.

[x] Executed concurrently with the execution of this instrument

WHEREAS, United Microelectronics Corp.

of No. 3, Li-Hsin Rd. II, Science-Based Industrial Park, Hsinchu, Taiwan, R.O.C.

hereinafter referred to as ASSIGNEE, is desirous of acquiring ASSIGNOR'S interest in the said invention and application and in any U.S. Letters Patent which may be granted on the same:

NOW, THEREFORE, TO ALL WHOM IT MAY CONCERN: Be it known that, for good and valuable consideration, receipt of which is hereby acknowledged by Assignor, Assignor has/have sold, assigned and transferred, and by these presents does/do sell, assign and transfer unto the said Assignee, and Assignee's successors and assigns, all his/her/their rights, title and interest in and to the said invention and application and all future improvements thereon, and in and to any Letters Patent which may hereafter be granted on the same in the United States, the said interest to be held and enjoyed by said Assignee as fully and exclusively as it would have been held and enjoyed by said Assignor had this Assignment and transfer not been made, to the full end and term of any Letters Patent which may be granted thereon, or of any division, renewal, continuation in whole or in part, substitution, conversion, reissue, prolongation or extension thereof.

Assignor further agrees/agree that he/she/they will, without charge to said Assignee, but at Assignee's expense, cooperate with Assignee in the prosecution of said application and/or applications, execute, verify, acknowledge and deliver all such further papers, including applications for Letters Patent and for the reissue thereof, and instruments of assignment and transfer thereof, and will perform such other acts as Assignee Lawfully may request, to obtain or maintain Letters Patent for said invention and improvement, and to vest title thereto in said Assignee, or Assignee's successors and assigns.

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ASSIGNMENT CONTINUED

IN TESTIMONY WHEREOF, As signor has/have signed his/her/their name(s) on the date(s) indicated.

Kai-Ling Chiu	Date:	>0°9. APR. >>
Sole or First Joint Inventor: Kai-Ling Chiu		
11 # a B		
Signature: Victor C. Kung	Date:	>009. APR. >>
Second Joint Inventor (if any): Victor Chiang Liang		
Signature: Chih Yu Tseng	Date:	roof. APR. N
Third Joint Inventor (if any): Chih-Yu Tseng	24(0)	
Signature: Hui-Sheng Chang	Date:	>00 P. APR. 20
Fourth Joint Inventor (if any): Hui-Sheng Chang		
Signature: Chia-Te Chien	Date:	>00 J. APR . 22
Fifth Joint Inventor (if any): Chla-Te Chien		•
signature: You-Ken Lin	Date:	>=of. APR. =r
Sixth Joint Inventor (if any): You-Ren Liu		

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